



High-end Power Semiconductor Manufacturer

KP4000A 1000V-1800V Phase Control Thyristor

- High power cycling capability
- Low on-state and switching losses
- Designed for traction and industrial applications



Mean on-state current		I _{TAV}	4000 A		
Repetitive peak off-state voltage		V _{DRM}	1000 – 1800 V		
Repetitive peak reverse voltage		V _{RRM}			
Turn-off time		t _q	320 μs		
V _{DRM} , V _{RRM} , V	1000	1200	1400	1600	1800
Voltage code	10	12	14	16	18
T _{ir} , °C	– 60 – 125				

MAXIMUM ALLOWABLE RATINGS

Symbols and parameters		Units	Values	Test conditions	
ON-STATE					
I _{TAV}	Mean on-state current	A	4000	T _c = 85 °C, Double side cooled 180° half-sine wave; 50 Hz	
I _{TRMS}	RMS on-state current	A	6280	T _c = 85 °C, Double side cooled 180° half-sine wave; 50 Hz	
I _{TSM}	Surge on-state current	kA	61.0	T _j =T _j max T _j =25 °C	180° half-sine wave; 50 Hz (t _p =10 ms); single pulse; V _D =V _R =0 V; Gate pulse: I _G =2 A; t _{GP} =50 μs; di _G /dt≥1 A/μs
			70.0	T _j =T _j max T _j =25 °C	180° half-sine wave; 60 Hz (t _p =8.3 ms); single pulse; V _D =V _R =0 V; Gate pulse: I _G =2 A; t _{GP} =50 μs; di _G /dt≥1 A/μs
I ² t	Safety factor	A ² ·10 ³	18608	T _j =T _j max T _j =25 °C	180° half-sine wave; 50 Hz (t _p =10 ms); single pulse; V _D =V _R =0 V; Gate pulse: I _G =2 A; t _{GP} =50 μs; di _G /dt≥1 A/μs
			24500	T _j =T _j max T _j =25 °C	180° half-sine wave; 60 Hz (t _p =8.3 ms); single pulse; V _D =V _R =0 V; Gate pulse: I _G =2 A; t _{GP} =50 μs; di _G /dt≥1 A/μs
BLOCKING					
V _{DRM} , V _{RRM}	Repetitive peak off-state and Repetitive peak reverse voltages	V	1000–1800	T _{j min} < T _j <T _{j max} ; 180° half-sine wave; 50 Hz; Gate open	
V _{DSM} , V _{RSM}	Non-repetitive peak off-state and Non-repetitive peak reverse voltages	V	1100–1900	T _{j min} < T _j <T _{j max} ; 180° half-sine wave; 50 Hz;single pulse; Gate open	
V _D , V _R	Direct off-state and Direct reverse voltages	V	0.75·V _{DRM} 0.75·V _{RRM}	T _j =T _j max; Gate open	

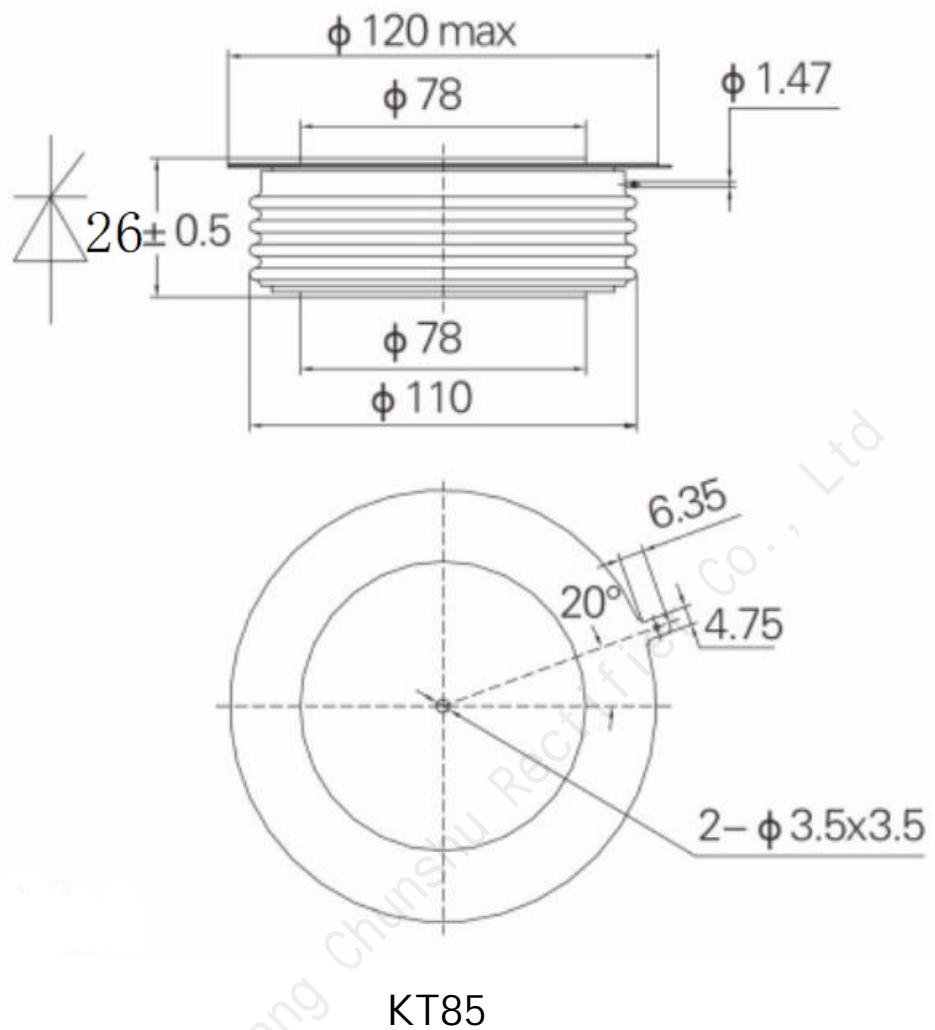
TRIGGERING				
I_{FGM}	Peak forward gate current	A	10	$T_j = T_{j \max}$
V_{RGM}	Peak reverse gate voltage	V	5	
P_G	Gate power dissipation	W	5	
SWITCHING				
$(di_T/dt)_{crit}$	Critical rate of rise of on-state current non-repetitive ($f=1$ Hz)	A/ μ s	630	$T_j = T_{j \max}; V_D = 0.67 \cdot V_{DRM}; I_{TM} = 2 I_{TAV};$ Gate pulse: $I_G = 2$ A; $t_{GP} = 50 \mu$ s; $di_G/dt \geq 1$ A/ μ s
THERMAL				
T_{stg}	Storage temperature	°C	-60 – 125	
T_j	Operating junction temperature	°C	-60 – 125	
MECHANICAL				
F	Mounting force	kN	60.0 – 70.0	
a	Acceleration	m/s ²	50 100	Device unclamped Device clamped

CHARACTERISTICS

Symbols and parameters		Units	Values	Conditions		
ON-STATE						
V_{TM}	Peak on-state voltage, max	V	1.55	$T_j = 25$ °C; $I_{TM} = 6300$ A		
$V_{T(TO)}$	On-state threshold voltage, max	V	0.90	$T_j = T_{j \max};$		
r_T	On-state slope resistance, max	$m\Omega$	0.100	$0.5 \pi I_{TAV} < I_T < 1.5 \pi I_{TAV}$		
I_L	Latching current, max	mA	1500	$T_j = 25$ °C; $V_D = 12$ V; Gate pulse: $I_G = 2$ A; $t_{GP} = 50 \mu$ s; $di_G/dt \geq 1$ A/ μ s		
I_H	Holding current, max	mA	300	$T_j = 25$ °C; $V_D = 12$ V; Gate open		
BLOCKING						
I_{DRM}, I_{RRM}	Repetitive peak off-state and Repetitive peak reverse currents, max	mA	200	$T_j = T_{j \max};$ $V_D = V_{DRM}; V_R = V_{RRM}$		
$(dv_D/dt)_{crit}$	Critical rate of rise of off-state voltage ¹⁾ , min	V/ μ s	1000	$T_j = T_{j \max};$ $V_D = 0.67 \cdot V_{DRM};$ Gate open		
TRIGGERING						
V_{GT}	Gate trigger direct voltage, max	V	3.00 2.00	$T_j = 25$ °C $T_j = T_{j \max}$	$V_D = 12$ V; $I_D = 3$ A; Direct gate current	
I_{GT}	Gate trigger direct current, max	mA	300 200	$T_j = 25$ °C $T_j = T_{j \max}$		
V_{GD}	Gate non-trigger direct voltage, min	V	0.35	$T_j = T_{j \max};$ $V_D = 0.67 \cdot V_{DRM};$ Direct gate current		
I_{GD}	Gate non-trigger direct current, min	mA	15.00			
SWITCHING						
t_{gd}	Delay time	μ s	4.00	$T_j = 25$ °C; $V_D = 0.4 \cdot V_{DRM};$ $I_{TM} = 2000$ A; Gate pulse: $I_G = 2$ A; $t_{GP} = 50 \mu$ s; $di_G/dt \geq 1$ A/ μ s		
t_q	Turn-off time ²⁾ , max	μ s	320	$dv_D/dt = 50$ V/ μ s; $T_j = T_{j \max};$ $I_{TM} = 2000$ A; $di_R/dt = -10$ A/ μ s; $V_R = 100$ V; $V_D = 0.67 \cdot V_{DRM};$		

THERMAL					
R_{thjc}	Thermal resistance, junction to case, max	$^{\circ}\text{C}/\text{W}$	0.0065	Direct current	Double side cooled
R_{thjc-A}			0.0143		Anode side cooled
R_{thjc-K}			0.0117		Cathode side cooled
R_{thck}	Thermal resistance, case to heatsink, max	$^{\circ}\text{C}/\text{W}$	0.0015	Direct current	
MECHANICAL					
W	Weight, typ	g	1900		
D_s	Surface creepage distance	mm (inch)	36.50 (1.437)		
D_a	Air strike distance	mm (inch)	16.5 (0.650)		

OVERALL DIMENSIONS



All dimensions in millimeters